



450V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)}	I _D T _A = +25°C
-450V	150Ω @ V_{GS} = -10V	-0.25A

Description

This 450V enhancement mode P-channel MOSFET provides users with a competitive specification offering efficient power handling capability, high impedance and is free from thermal runaway and thermally induced secondary breakdown. Applications benefiting from this device include a variety of Telecom and general high voltage switching circuits.

Applications

- Load Switching
- Uninterrupted Power Supply

Features and Benefits

- Low Gate Drive
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

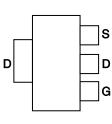
Mechanical Data

- Case: SOT223
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 🚳
- Weight: 0.112 grams (Approximate)

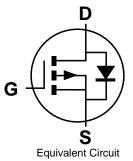


SOT223

Top View



Pin Out - Top View



Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
DMP45H150DHE-13	Standard	SOT223	2,500/Tape & Reel

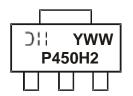
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



Constant III = Manufacturer's Marking P450H2 = Marking Code YWW = Date Code Marking Y or \overline{Y} = Year (ex: 7 = 2017) WW = Week (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	-450	V
Gate-Source Voltage		V _{GSS}	±30	V
Continuous Drain Current (Note 5) V _{GS} =- 10V	$T_{C} = +25^{\circ}C$ $T_{C} = +70^{\circ}C$	Ι _D	-0.25 -0.20	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	-0.45	A
Maximum Body Diode Continuous Current		Is	-0.45	А
Avalanche Energy (Note 6) L=60mH		E _{AS}	4	mJ
Avalanche Current (Note 6) L=60mH	las	0.25	A	
Peak Diode Recovery dv/dt ($I_{SD} \le 1.0A$, di/dt $\le 100A/\mu s$)	dv/dt	4.5	V/ns	

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Dower Discinction (Note 6)	$T_{C} = +25^{\circ}C$	P	13.9	W
Total Power Dissipation (Note 6)	T _C = +70°C	PD	8.9	°C/W
Thermal Resistance, Junction to Ambient	(Note 6)	R _{0JA}	59.4	W
Thermal Resistance, Junction to Case	(Note 6)	R _{θJC}	8.9	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

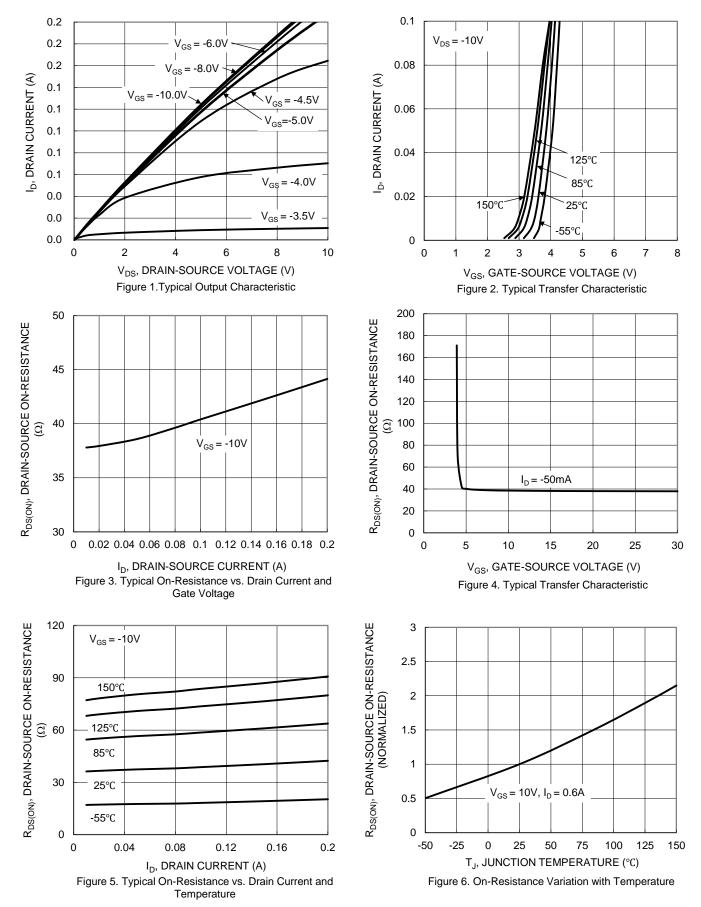
			_			
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 5)			1			
Drain-Source Breakdown Voltage	BV _{DSS}	-450	—	—	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}		—	-1	μA	$V_{DS} = -450V, V_{GS} = 0V$
Gate-Source Leakage	IGSS		—	±100	nA	$V_{GS} = \pm 30V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 5)						
Gate Threshold Voltage	V _{GS(TH)}	-2.0	-3.0	-4.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
Static Drain-Source On-Resistance	R _{DS(ON)}		40	150	Ω	$V_{GS} = -10V, I_D = -50mA$
Diode Forward Voltage	V _{SD}		-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -50mA$
DYNAMIC CHARACTERISTICS (Note 6)	•					
Input Capacitance	CISS	_	59.2	_		V _{DS} = -25V, V _{GS} = 0V, f = 1.0MHz
Output Capacitance	C _{OSS}		11	_	pF	
Reverse Transfer Capacitance	C _{RSS}		1	_		
Forward Transconductance	g FS	40	_	_	ms	V _{DS} =-25V,I _D =-50mA
Gate Resistance	R _G		50	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge	Q _G		1.8			V_{DS} = -225V, I_{D} = -100mA, V_{GS} = -
Gate-Source Charge	Q _{GS}		0.3		nC	
Gate-Drain Charge	Q _{GD}		0.9			10V
Turn-On Delay Time	t _{D(ON)}		12			
Turn-On Rise Time	t _R		9			V_{DD} = -225V, R_{G} = 3.0 Ω , I_{D} = -100mA
Turn-Off Delay Time	t _{D(OFF)}		19	_	ns	
Turn-Off Fall Time	tF		87			
Body Diode Reverse Recovery Time	t _{RR}	_	108	_	ns	$V_{GS} = 0V, I_S = -100mA, VDD=-100V, di/dt = 100A/\mu s$
Body Diode Reverse Recovery Charge	Q _{RR}		391		nC	V _{GS} = 0V, I _S =-100mA, VDD=-100V ,di/dt = 100A/µs

 Notes:
 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1 inch square copper pad layout.

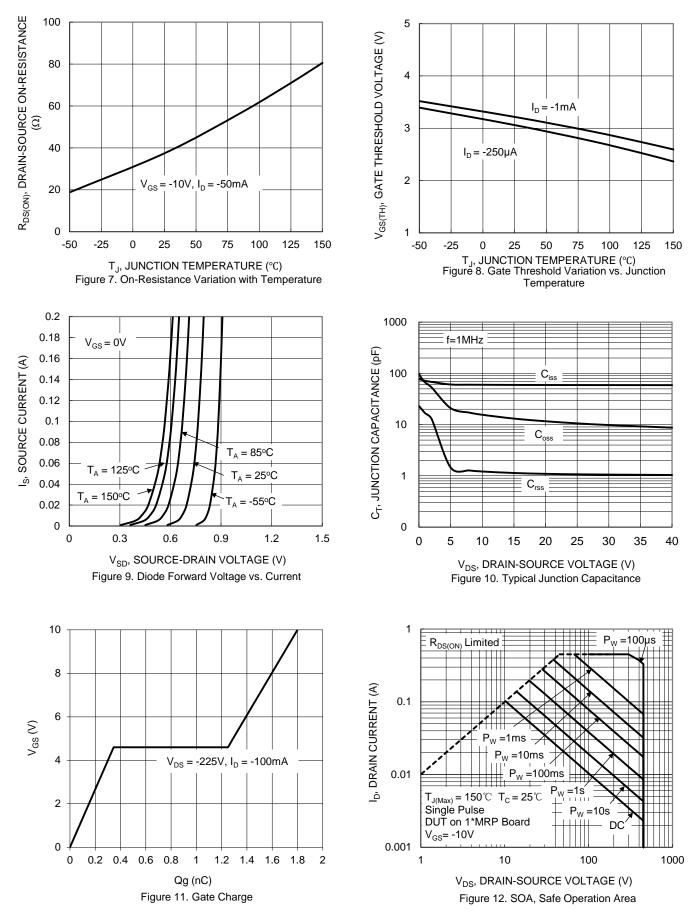
 6. Guaranteed by design. Not subject to production testing.



DMP45H150DHE





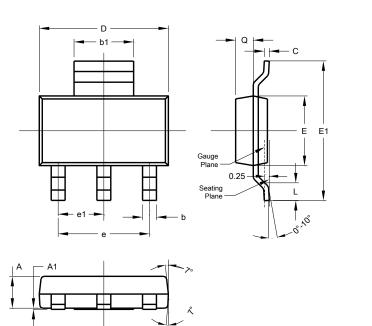


DMP45H150DHE Document Number DS39212 Rev. 3 - 2



Package Outline Dimensions

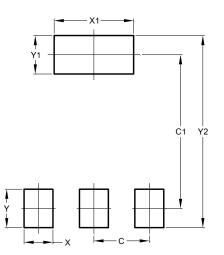
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT223					
Dim	Min	Min Max Ty			
Α	1.55	1.65	1.60		
A1	0.010	0.15	0.05		
b	0.60	0.80	0.70		
b1	2.90	3.10	3.00		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
Е	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е	-	-	4.60		
e1	-	-	2.30		
L	0.85	1.05	0.95		
Q	0.84	0.94	0.89		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT223

Dimensions	Value (in mm)
С	2.30
C1	6.40
Х	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00

SOT223



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